A wide variety of products including dust-proof type







Typical Specifications

Items	Specifications
Rating (max.)	50mA 12V DC
Rating (min.)	10μA 1V DC
Initial contact resistance	100mΩ max.
Travel (mm)	0.25

■ Product Line

Top push type

Product No.	Operating force	Operating direction	Operating life (5mA 5V DC)	Stem color	Stem height	Minimum ord Japan	er unit (pcs.) Export	Drawing No.
SKHUAKE010	0.98N		200,000 avalas	Green			·	
SKHUALE010	1.57N	Top push	300,000 cycles	Black	2.5mm	3,000	3,000	1
SKHUAME010	2.55N		100,000 cycles	Red	1			

With ground terminal type

Product No.	Operating force	Operating Operating life Stem color Stem		Stem height	Minimum ord	Drawing			
T TOUGET NO.	Operating force	direction	(5mA 5V DC)		Otem neight	Japan	Export	No.	
SKHUPKE010	0.98N		300.000 cycles	Green					
SKHUPLE010	1.57N	Top push	300,000 cycles	300,000 Cycles	Black	2.5mm	3,000	3,000	2
SKHUPME010	2.55N		100,000 cycles	Red					

Dust-proof type

Product No.	Operating force	Operating	Operating life			Minimum ord	Drawing	
T TOUGET NO.	Operating force	direction	(5mA 5V DC)	Sterri Goldi	Stem height	Japan	Export	No
SKHUBHE010	1.57N	Top push	50,000 cycles	Brown	3.1mm	3,000	3,000	3

Dust-proof and with ground terminal type

Product No.	Operating force	Operating	Operating life	Stem color	Stem height	Minimum ord	er unit (pcs.)	Drawing
T TOUGGE TNO.	Operating force	direction	(5mA 5V DC)	Otern color	Sterr Color Sterr Height	Japan	Export	No
SKHUQHE010	1.57N	Top push	50,000 cycles	Brown	0.1	3.000	3.000	1
SKHUQGE010	2.55N	τορ ραδιτ		Red	3.1mm	3,000	3,000	4

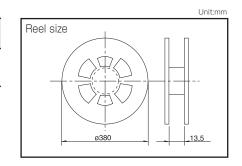
■ Packing Specifications

Taping

Num	ber of packages (Tape width	Export package	
1 reel	1 case / Japan	1 case / export packing	(mm)	measurements (mm)
3,000	30,000	30,000	12	395×395×205

Note

For reels of 330mm diameter, please inquire.

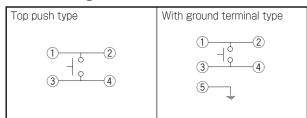




■ Dimensions Unitmm

No.	Photo	Style	PC board land dimensions (Viewed from switch mounting face)
1	Top push type	7.2 6.2 8'S 8'S 3	9.5
2	With ground terminal type	7.2 6.2 2 2 3 3 5 5 8 8 9	9.5 4 Ground terminal land Q 7 Q 1 V
3	Dust-proof type	7.2 6.2 8 9 9	9.5
4	Dust-proof and with ground terminal type	7.2 6.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0.2 0	9.5 4 Ground terminal land Q 7 Q Q 1 Q

Circuit Diagram





	Type				Sharp Fee	eling Type				
	.,,,,				Surface	e Mount				
	Series	SKHU	SKTD	SKSN	SKTG	SKSL	SKSC	SKRT	SKRH	
	Photo	100				0	Sale Park		4	
	Features	_	Low-profile	Mid-mount	Half-n	nount	Low-profile	_	4-direction switch +push switch	
	Water-proof	0	•	_	•	_	_	_	_	
	Dust-proof	0	•	_	•	_	_	_	_	
	IP standard	_	67 equivalency	_	67 equivalency	_	_	_	_	
Operatir		•	_	_	_	_	_	_	•	
directio	n Side push	_	•	•	•	•	•	•	•	
	W	6.2	3.9	6.2	5.2	4.5	3.5	4.5	7.35	
Dimensio (mm)	ons D	6.3	2.9	3	3.5	2.6	3.55	3.4	7.5	
	Н	2.5/3.1	1.55	3.5	1.55	2.2	1.25	3.3	5	
Operation force coverage	2N to 3N		\$	\$	\$	Ţ	Ţ	\$	See the relevant pages for respective product description	
	Travel (mm)	0.25	0.15	0.2	0.	0.15		1.2	See the relevant pages for respective product description	
Gi	round terminal	•	•	•	•	•	0	•	•	
Operatin	g temperature range	-40℃ to +85℃	-30°C to +85°C	-40°C to +85°C	-30°C to +85°C -40°C to		-40℃ to +90℃	-40°C to +85°C		
Aı	utomotive use	0	_	_	_	_	_	_	_	
	Life Cycle	* 3	* 2	* 2	* 2	* 2	* 2	* 2	* 2	
	Rating (max.) (Resistive load)	50mA 12V DC								
Electrical	Rating (min.) (Resistive load)	10μA 1V DC								
performance	Insulation resistance				100MΩ min. 10	00V DC 1min.				
	Voltage proof	250V AC 1min.	100V AC 1min.	250V A	C 1min.	100V A	C 1min.	250V AC 1min.	100V AC 1min.	
Durability	Vibration		10 to	55 to 10Hz/m in the 3 dired	nin., the amplitu ction of X, Y an	de is 1.5mm fo d Z for 2 hours	or all the freque s respectively	encies,		
Durability	Lifetime			Shall be in a	accordance wit	h individual sp	ecifications.			
	Cold	Cold −40°C 96h								
Environmental performance	Dry heat	90℃ 96h	85℃ 96h	90℃ 96h	85℃ 96h		90°C	96h		
	Damp heat				60°C, 90 to 9	95%RH 96h				
	Page	242	244	245	246	247	248	250	465	

W : Width. The most outer dimension excluding terminal portion. D : Depth. The most outer dimension excluding terminal portion.

H: Height. The minimum dimension if there are variances.

Notes

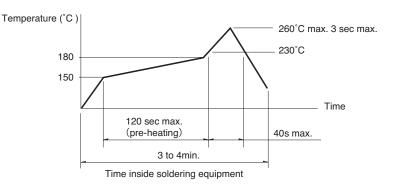
- 1. The automotive operating temperature range to be individually discussed upon request.
- 2. lacktriangle Indicates applicability to all products in the series, while \bigcirc indicates applicability to some products in the series.

TACT Switch™ Soldering Conditions

Condition for Reflow

Available for Surface Mount Type.

- 1. Temperature measurement: Thermocouple ϕ 0.1 to 0.2 CA (K) or CC (T) at solder joints (copper foil surface).
 - A heat resistive tape should be used to fix thermocouple.
- 2. Temperature profile



Notes

- The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others.
 The above-stated conditions shall also apply to switch surface temperatures.
- Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip

Available for Snap-in Type and Radial Type.

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	60s max.
Soldering temperature	260℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH, SKPD Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKQJ, SKQK, SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to flux
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255℃ max.
Duration of immersion	5s max.
Number of soldering	2times max.

Manual Soldering

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH, SKHW, SKRG, SKPD Series

Items	Condition
Soldering temperature	360°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKTD, SKTG, SKQJ, SKQK, SKEG Series

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	20W max.

Notes

- 1. Prevent flux penetration from the top side of the TACT Switch™.
- 2. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 3. The second soldering should be done after the switch is stable with normal temperature.
- 4. Use the flux with a specific gravity of min 0.81. (EC-19S-8 by TAMURA Corporation, or equivalents.)

